#### 505347391 02/26/2019

### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
ISABEL CRISTINA CHU	12/19/2017
LAWRENCE A. CLEVENGER	12/19/2017
LEIGH ANNE H. CLEVENGER	12/14/2017
EKMINI ANUJA DE SILVA	12/15/2017
GAURI KARVE	12/15/2017
FEE LI LIE	12/15/2017
NICOLE ADELLE SAULNIER	12/15/2017
INDIRA SESHADRI	12/15/2017
HOSADURGA SHOBHA	12/15/2017

### **RECEIVING PARTY DATA**

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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16286072

### **CORRESPONDENCE DATA**

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PATENT

REEL: 048445 FRAME: 0315 505347391

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DATE SIGNED:	02/26/2019
Total Attachments: 9	
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## DECLARATION (37 C.F.R. § 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. § 1.76) AND ASSIGNMENT

Title of Invention: DIELECTRIC GAP FILL EVALUATION FOR INTEGRATED CIRCUITS

As a below named and undersigned inventor, I hereby declare that:	
This declaration is directed to the attached application, or (if following box is chec	ked):
[] United States application or PCT international application number	filed on
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed in application.	vention in the
I have reviewed and understand the contents of the application, including the claim	18.
The second of th	1000 41

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged. I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefore in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: Isabel Cristina Chu		
Signature: Cristna Cha P	Date: \Z/19//7	
(2) Legal Name of Inventor: Lawrence A. Clevenger		
Signature:	Date:	
(3) Legal Name of Inventor: Leigh Anne H. Clevenger		
Signature:	Date:	
(4) Legal Name of Inventor: Ekmini Anuja De Silva		
Signature: Ade	Date: 12/15/17	

(5) Legal Name of Inventor: Gauri Karve

Signature:	Date:	
(6) Legal Name of Inventor: Fee Li Lie		
Signature:	Date:	
(7) Legal Name of Inventor: Nicole Adelle Saulnier		
Signature:	Date:	
(8) Legal Name of Inventor: Indira Seshadri		
Signature:	Date;	
(9) Legal Name of Inventor: <b>Hosadurga Shobha</b>		
Cinneton	Data	

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(1) Legai ivanie di inventor. Isabel Cistina Ciu		
Signature:	Date:	<del>,,,,,,,,</del>
(2) Legal Name of Inventor: Lawrence A. Clevenger		
(2) Light value of Inventor. Lawrence A. Cievenger	Albert John State Control	
Signature:	Date:	
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(5) Legal Name of Inventor: Gauri Karve	Marie Carlos de	

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Signature: Trube A Lawhare	Date:	12/15/2017
(8) Legal Name of Inventor: Indira Seshadri		e e e e e e e e e e e e e e e e e e e
Signature:	Date:	r/15/2017
(9) Legal Name of Inventor: Hosadurga Shobha	i i	
Signature:	Date	19/12/2017

PATENT REEL: 048445 FRAME: 0325

RECORDED: 02/26/2019